

Is Now Part of



# **ON Semiconductor**®

# To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="https://www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="https://www.onsemi.com">Fairchild\_questions@onsemi.com</a>.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized applications, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an equif prese





## 74LCX245 Low Voltage Bidirectional Transceiver with 5V Tolerant Inputs and Outputs

### Features

- 5V tolerant inputs and outputs
- 2.3V to 3.6V V<sub>CC</sub> specifications provided
- 7.0ns t<sub>PD</sub> max. (V<sub>CC</sub> = 3.3V), 10µA I<sub>CC</sub> max.
- Power down high impedance inputs and outputs
- Supports live insertion/withdrawal<sup>(1)</sup>
- $\pm 24$ mA output drive (V<sub>CC</sub> = 3.0V)
- Implements proprietary noise/EMI reduction circuitry
- Latch-up performance exceeds 500mA
- ESD performance:
  - Human body model > 2000V
  - Machine model > 200V
- Leadless DQFN package

#### Note:

 To ensure the high-impedance state during power up or down, OE should be tied to V<sub>CC</sub> through a pull-up resistor: the minimum value or the resistor is determined by the current-sourcing capability of the driver.

### **General Description**

The LCX245 contains eight non-inverting bidirectional buffers with 3-STATE outputs and is intended for bus oriented applications. The device is designed for low voltage (2.5V and 3.3V) V<sub>CC</sub> applications with capability of interfacing to a 5V signal environment. The T/R input determines the direction of data flow through the device. The  $\overline{OE}$  input disables both the A and B ports by placing them in a high impedance state.

The LCX245 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

### **Ordering Information**

Order Number	Package Number	Package Description
74LCX245WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74LCX245SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74LCX245BQX <sup>(2)</sup>	MLP20B	20-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 4.5mm
74LCX245MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide
74LCX245MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

#### Note:

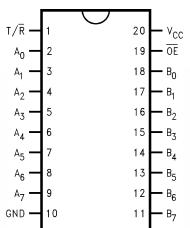
2. DQFN package available in Tape and Reel only.

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

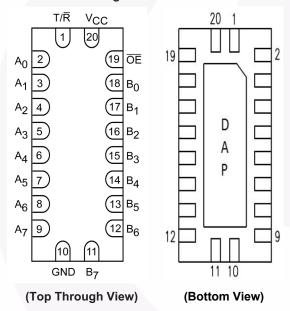
All packages are lead free per JEDEC: J-STD-020B standard.

### **Connection Diagrams**

Pin Assignments for SOIC, SOP, SSOP, and TSSOP



#### Pin Assignment for DQFN

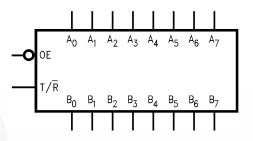


### **Pin Description**

Pin Names	Description	
ŌĒ	Output Enable Input	
T/R	Transmit/Receive Input	
A <sub>0</sub> -A <sub>7</sub>	Side A Inputs or 3-STATE Outputs	
B <sub>0</sub> –B <sub>7</sub>	Side B Inputs or 3-STATE Outputs	
DAP	No Connect	

Note: DAP (Die Attach Pad)

### Logic Symbol



### Truth Table

Inputs		
OE	T/R	Outputs
L	L	Bus $B_0 - B_7$ Data to Bus $A_0 - A_7$
L	Н	Bus $A_0 - A_7$ Data to Bus $B_0 - B_7$
Н	Х	HIGH Z State on $A_0 - A_7$ , $B_0 - B_7^{(3)}$

H = HIGH Voltage Level

L = LOW Voltage Level

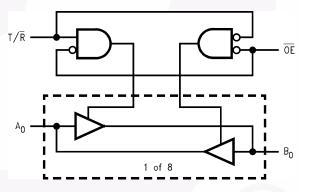
X = Immaterial

Z = High Impedance

#### Note:

3. Unused bus terminals during HIGH Z State must be held HIGH or LOW.

### Logic Diagram



### **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
V <sub>CC</sub>	Supply Voltage	–0.5V to +7.0V
VI	DC Input Voltage	-0.5V to +7.0V
Vo	DC Output Voltage	
	Output in 3-STATE	-0.5V to +7.0V
	Output in HIGH or LOW State <sup>(4)</sup>	–0.5V to V <sub>CC</sub> + 0.5V
I <sub>IK</sub>	DC Input Diode Current, V <sub>I</sub> < GND	–50mA
I <sub>OK</sub>	DC Output Diode Current	
	V <sub>O</sub> < GND	–50mA
	V <sub>O</sub> > V <sub>CC</sub>	+50mA
Ι <sub>Ο</sub>	DC Output Source/Sink Current	±50mA
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100mA
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100mA
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C

Note:

4. I<sub>O</sub> Absolute Maximum Rating must be observed.

### Recommended Operating Conditions<sup>(5)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Supply Voltage			
	Operating	2.0	3.6	V
	Data Retention	1.5	3.6	
VI	Input Voltage	0	5.5	V
Vo	Output Voltage			
	3-STATE	0	5.5	V
	HIGH or LOW State	0	V <sub>CC</sub>	
I <sub>OH</sub> / I <sub>OL</sub>	Output Current			
	$V_{CC} = 3.0V - 3.6V$		±24	mA
	$V_{CC} = 2.7V - 3.0V$		±12	
	V <sub>CC</sub> = 2.3V–2.7V		±8	
T <sub>A</sub>	Free-Air Operating Temperature	-40	85	°C
$\Delta t / \Delta V$	Input Edge Rate, $V_{IN} = 0.8V-2.0V$ , $V_{CC} = 3.0V$	0	10	ns/V

#### Note:

5. Unused inputs must be held HIGH or LOW. They may not float.

### **DC Electrical Characteristics**

				$T_A = -40^{\circ}C$	to +85°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min.	Max.	Units
V <sub>IH</sub>	HIGH Level Input Voltage	2.3–2.7		1.7		V
		2.7–3.6		2.0		
V <sub>IL</sub>	LOW Level Input Voltage	2.3–2.7			0.7	V
		2.7–3.6			0.8	]
V <sub>OH</sub>	HIGH Level Output Voltage	2.3–3.6	I <sub>OH</sub> = -100μA	V <sub>CC</sub> – 0.2		V
		2.3	I <sub>OH</sub> = -8mA	1.8		]
		2.7	$I_{OH} = -12mA$	2.2		]
		3.0	$I_{OH} = -18mA$	2.4		]
			$I_{OH} = -24mA$	2.2		]
V <sub>OL</sub>	LOW Level Output Voltage	2.3–3.6	I <sub>OL</sub> = 100μA		0.2	V
		2.3	I <sub>OL</sub> = 8mA		0.6	]
		2.7	I <sub>OL</sub> = 12mA		0.4	]
		3.0	I <sub>OL</sub> = 16mA		0.4	]
			$I_{OL} = 24 \text{mA}$		0.55	
I	Input Leakage Current	2.3–3.6	$0 \le V_I \le 5.5V$		±5.0	μA
I <sub>OZ</sub>	3-STATE Output Leakage	2.3–3.6	$0 \le V_O \le 5.5V,$ V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>		±5.0	μA
I <sub>OFF</sub>	Power-Off Leakage Current	0	$V_{\rm I}$ or $V_{\rm O} = 5.5 V$		10	μA
I <sub>CC</sub>	Quiescent Supply Current	2.3–3.6	$V_{I} = V_{CC}$ or GND		10	μA
			$3.6V \le V_I, V_O \le 5.5V^{(6)}$		±10	
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	2.3–3.6	$V_{\rm IH} = V_{\rm CC} - 0.6V$		500	μA

#### Note:

6. Outputs disabled or 3-STATE only.

### **AC Electrical Characteristics**

	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C, R_L = 500\Omega$							
		V <sub>CC</sub> = 3.3 C <sub>L</sub> =	3V ± 0.3V, 50pF		2.7V, 50pF	V <sub>CC</sub> = 2.5 C <sub>L</sub> =		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Units
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay, A <sub>n</sub> to B <sub>n</sub> or B <sub>n</sub> to A <sub>n</sub>	1.5	7.0	1.5	8.0	1.5	8.4	ns
t <sub>PZL</sub> , t <sub>PZH</sub>	Output Enable Time	1.5	8.5	1.5	9.5	1.5	10.5	ns
t <sub>PLZ</sub> , t <sub>PHZ</sub>	Output Disable Time	1.5	7.5	1.5	8.5	1.5	9.0	ns
t <sub>OSHL</sub> , t <sub>OSLH</sub>	Output to Output Skew <sup>(7)</sup>		1.0					ns

Note:

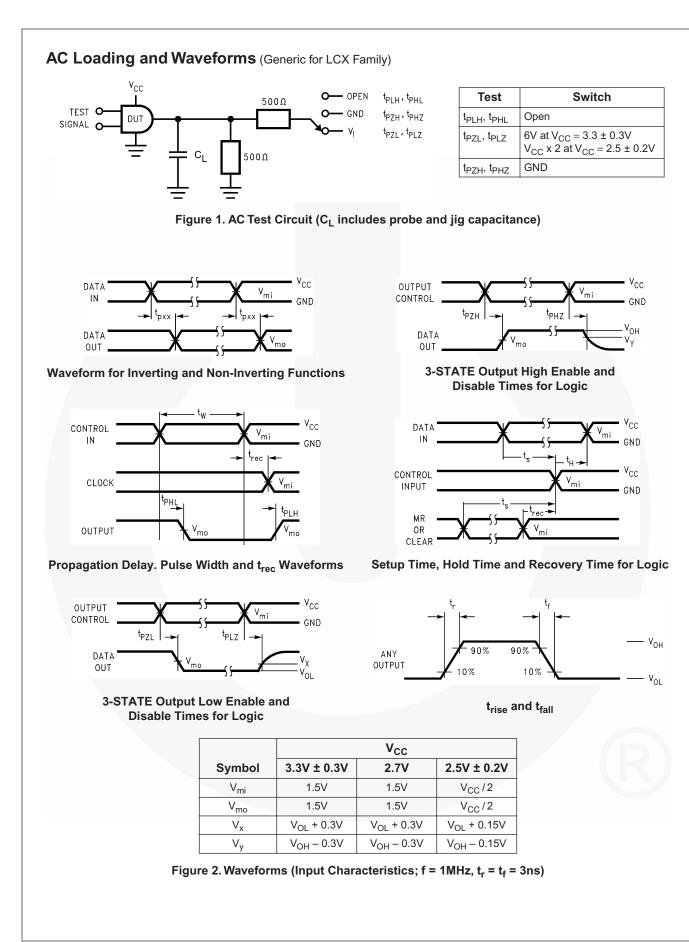
 Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>).

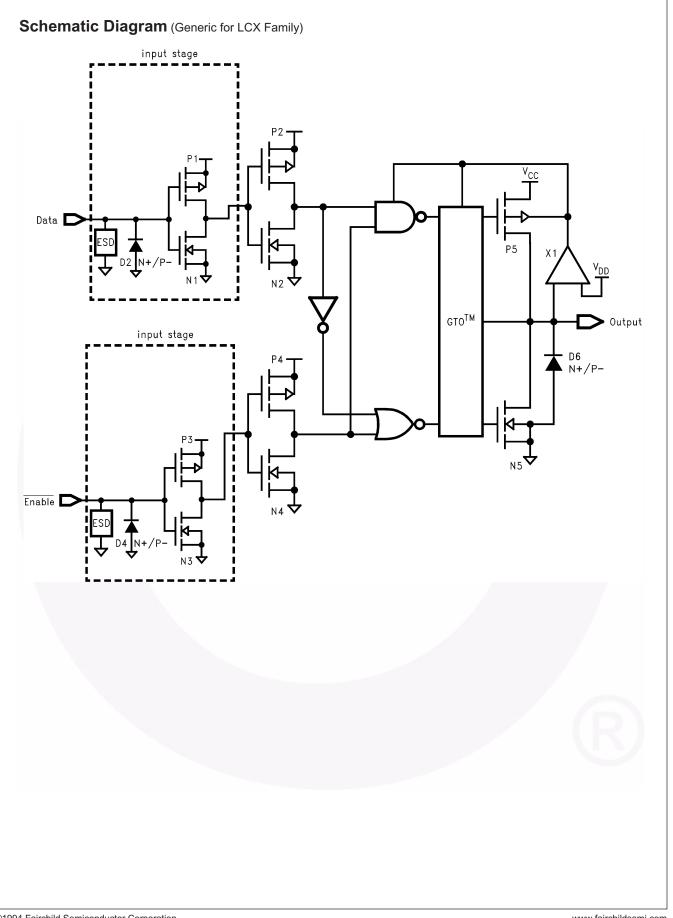
### **Dynamic Switching Characteristics**

				$T_A = 25^{\circ}C$	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Typical	Unit
V <sub>OLP</sub>	Quiet Output Dynamic Peak V <sub>OL</sub>	3.3	$C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$	0.8	V
		2.5	$C_L = 30 pF$ , $V_{IH} = 2.5 V$ , $V_{IL} = 0 V$	0.6	
V <sub>OLV</sub>	Quiet Output Dynamic Valley V <sub>OL</sub>	3.3	$C_L = 50 pF, V_{IH} = 3.3V, V_{IL} = 0V$	-0.8	V
		2.5	$C_{L} = 30 pF, V_{IH} = 2.5V, V_{IL} = 0V$	-0.6	

### Capacitance

Symbol	Parameter	Conditions	Typical	Units
C <sub>IN</sub>	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	7.0	pF
C <sub>OUT</sub>	Output Capacitance	$V_{CC} = 3.3$ V, $V_I = 0$ V or $V_{CC}$	8.0	pF
C <sub>PD</sub>	Power Dissipation Capacitance	$V_{CC}$ = 3.3V, $V_{I}$ = 0V or $V_{CC}$ , f = 10MHz	25.0	pF



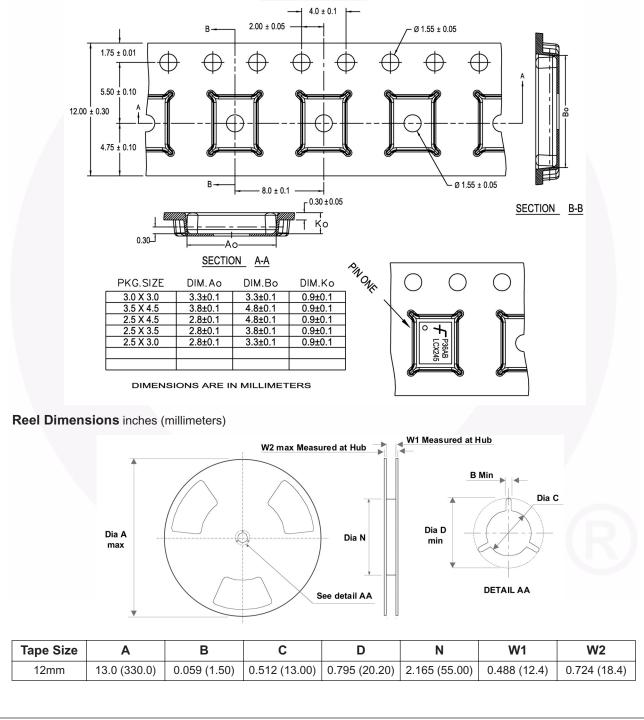


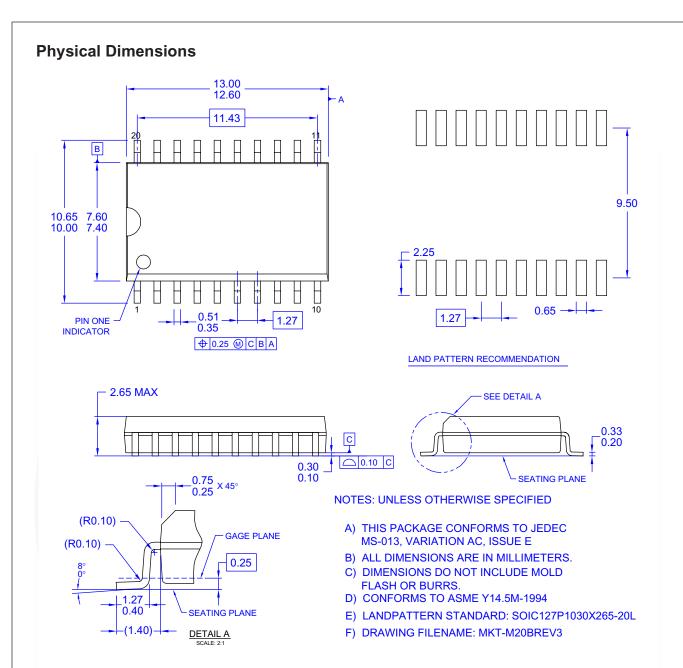
### **Tape and Reel Specification**

### Tape Format for DQFN

Package Designator	Tape Section	Number of Cavities	<b>Cavity Status</b>	Cover Tape Status
BQX	Leader (Start End)	125 (typ.)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ.)	Empty	Sealed

#### Tape Dimension inches (millimeters)

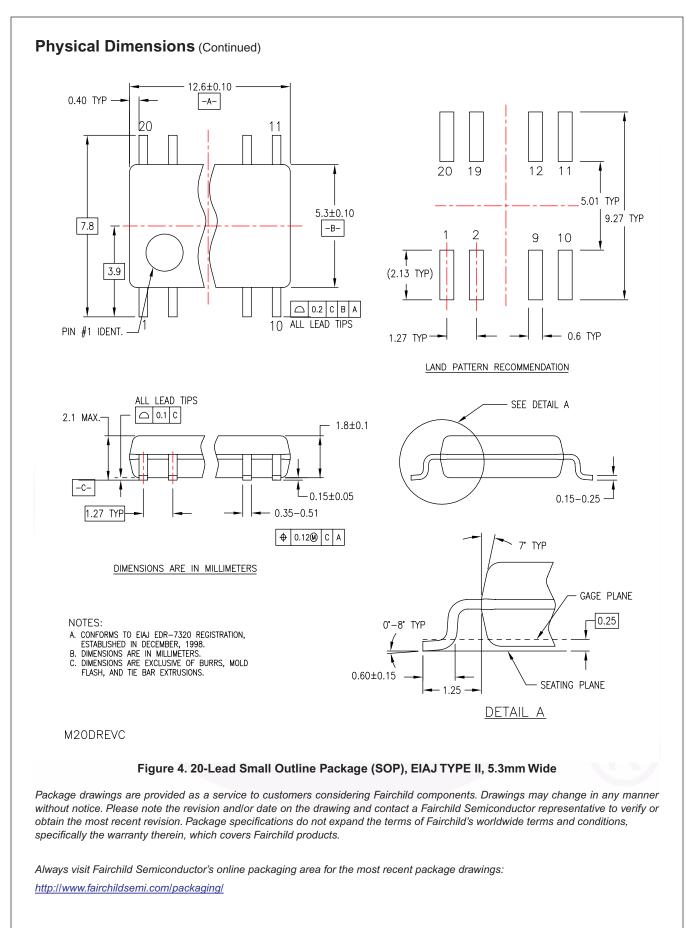


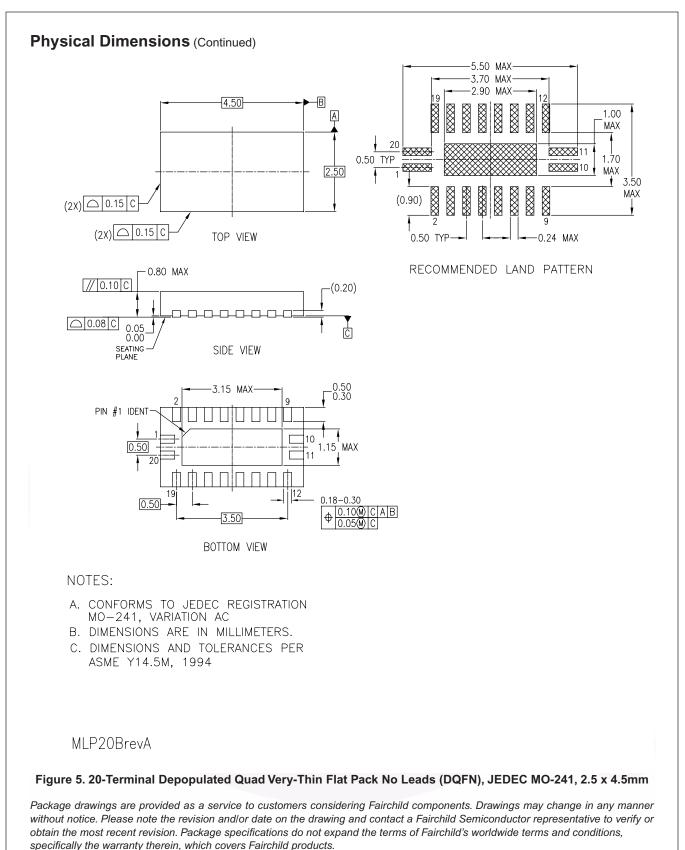


#### Figure 3. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <u>http://www.fairchildsemi.com/packaging/</u> 74LCX245 — Low Voltage Bidirectional Transceiver with 5V Tolerant Inputs and Outputs

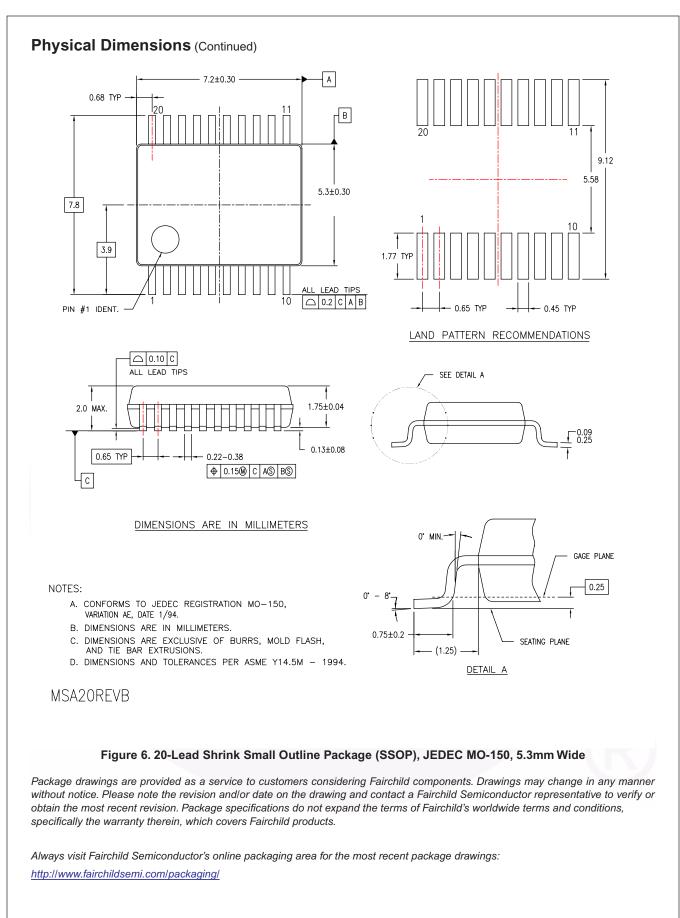


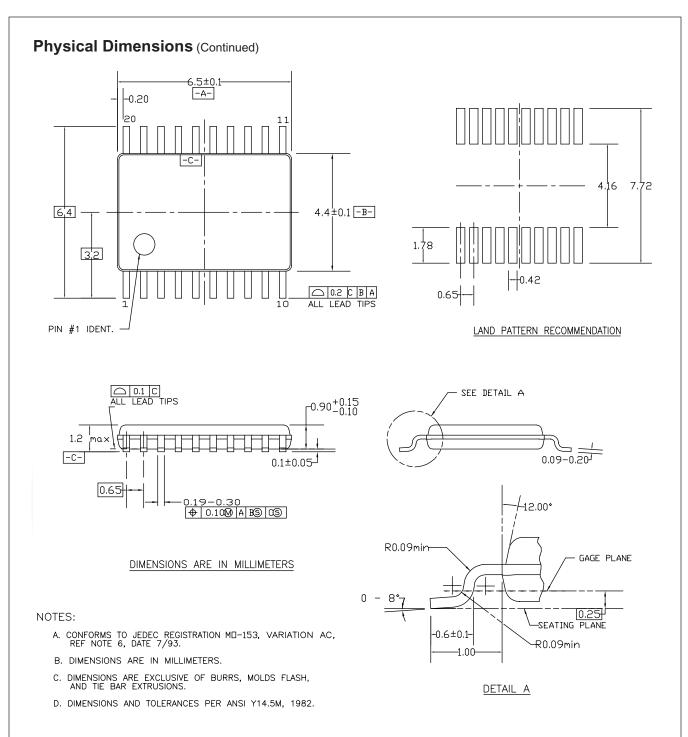


Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

74LCX245 — Low Voltage Bidirectional Transceiver with 5V Tolerant Inputs and Outputs





### MTC20REVD1

#### Figure 8. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:

http://www.fairchildsemi.com/packaging/

### FAIRCHILD

SEMICONDUCTOR

#### TRADEMARKS

AccuPower™

Build it Now™

CorePLUS™

DEUXPEED®

Dual Cool™

EcoSPARK<sup>®</sup>

EfficientMax™

®

Fairchild®

FACT

FAST®

**FPS™** 

FastvCore™

FETBench™

FACT Quiet Series™

ESBC™

CorePOWER™

CROSSVOLT™

Current Transfer Logic™

AX-CAP®,

BitSiC™

CTL™

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

F-PFS™ FRFET® Global Power Resource<sup>™</sup> GreenBridge™ Green FPS™ Green FPS™ e-Series™ Gmax™ GTO™ IntelliMAX™ ISOPLANAR™ Making Small Speakers Sound Louder and Better™ MegaBuck™ MICROCOUPLER™ MicroFET™ MicroPak™ MicroPak2™ Fairchild Semiconductor® MillerDrive™ MotionMax™ mWSaver OptoHiT™ **OPTOLOGIC<sup>®</sup> OPTOPLANAR<sup>®</sup>** 

PowerTrench<sup>®</sup> PowerXS<sup>T</sup> Programmable Active Droop™ QFET QS™ Quiet Series™ RapidConfigure™ ◯™ Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™ SPM<sup>®</sup> STEALTH™ SuperFET<sup>®</sup> SuperSOT™-3 SuperSOT™-6 SuperSOT™-8 SupreMOS<sup>®</sup> SyncFET™

TinyBoost<sup>®</sup> TinyBuck

Sync-Lock™

TinyCalc™ TinyLogic® TINYOPTO™ TinyPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™ TRUECURRENT®\* µSerDes™

**UHC**<sup>®</sup> Ultra FRFET™ UniFET™ VCX™ VisualMax™ VoltagePlus™ XS™

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### **PRODUCT STATUS DEFINITIONS**

Definition of	Terms
---------------	-------

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 166

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC

# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

onsemi:

74LCX245WMX 74LCX245MTCX 74LCX245WM 74LCX245BQX 74LCX245MTC